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Team Nexperia



BC856S

65 V, 100 mA PNP/PNP general-purpose transistor Rev. 02 — 19 February 2009 Produ

Product data sheet

1. Product profile

1.1 General description

PNP/PNP general-purpose transistor pair in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package.

1.2 Features

- Low collector capacitance
- Low collector-emitter saturation voltage
- Closely matched current gain
- Reduces number of components and board space
- No mutual interference between the transistors

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|---------------------------|--|-----|-----|------|------|
| Per trans | istor | | | | | |
| V_{CEO} | collector-emitter voltage | open base | - | - | -65 | V |
| I _C | collector current | | - | - | -100 | mA |
| h _{FE} | DC current gain | $V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$ | 110 | - | - | |

Pinning information

Table 2. **Pinning**

| I GIOTO E. | · ···································· | | |
|------------|--|--------------------|----------------|
| Pin | Description | Simplified outline | Graphic symbol |
| 1 | emitter TR1 | | |
| 2 | base TR1 | 6 5 4 | 6 5 4 |
| 3 | collector TR2 | | TR2 |
| 4 | emitter TR2 | 0 | (TR1) |
| 5 | base TR2 | □1 □2 □3 | |
| 6 | collector TR1 | | 1 2 3 |
| | | | sym018 |
| | | | |



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3. Ordering information

Table 3. Ordering information

| Type number | nber Package | | |
|-------------|--------------|--|---------|
| | Name | Description | Version |
| BC856S | SC-88 | plastic surface-mounted package; 6 leads | SOT363 |

4. Marking

Table 4. Marking codes

| Type number | Marking code ^[1] |
|-------------|-----------------------------|
| BC856S | 5F* |

^{[1] * = -:} made in Hong Kong

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit | | | |
|------------------|---------------------------|--------------------------|--------------|------|------|--|--|--|
| Per transis | Per transistor | | | | | | | |
| V_{CBO} | collector-base voltage | open emitter | - | -80 | V | | | |
| V_{CEO} | collector-emitter voltage | open base | - | -65 | V | | | |
| V_{EBO} | emitter-base voltage | open collector | - | -5 | V | | | |
| I _C | collector current | | - | -100 | mA | | | |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | <u>[1]</u> _ | 220 | mW | | | |
| | | | [2] _ | 250 | mW | | | |
| Per device | | | | | | | | |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | <u>[1]</u> _ | 300 | mW | | | |
| | | | [2] - | 400 | mW | | | |
| Tj | junction temperature | | - | 150 | °C | | | |
| T _{amb} | ambient temperature | | -65 | +150 | °C | | | |
| T _{stg} | storage temperature | | -65 | +150 | °C | | | |

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

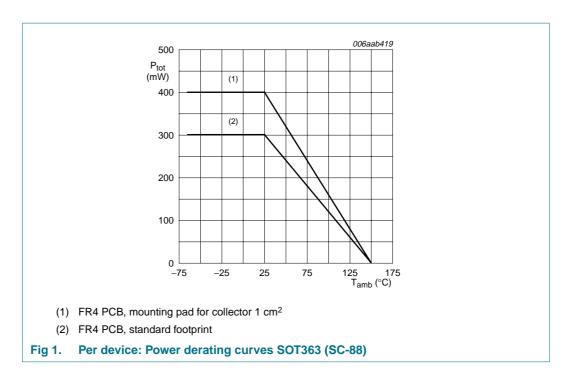
^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

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6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--|-------------|--------------|-----|-----|------|
| Per transist | or | | | | | |
| · -ui(j-a) | thermal resistance from junction to ambient | | <u>[1]</u> _ | - | 568 | K/W |
| | | | [2] _ | - | 500 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | - | - | 230 | K/W |
| Per device | | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | <u>[1]</u> _ | - | 416 | K/W |
| | | | [2] _ | - | 313 | K/W |

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

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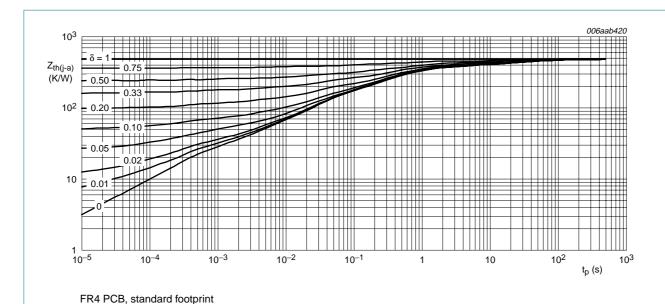


Fig 2. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration;

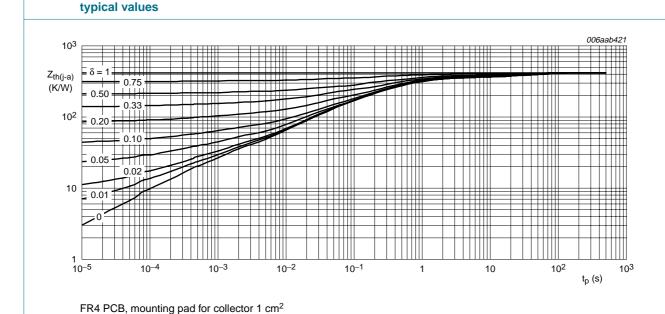


Fig 3. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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7. Characteristics

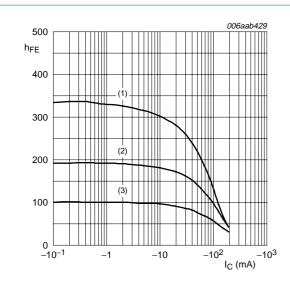
Table 7. Characteristics

 $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|--------------------------------------|--|------|------|------------|------|
| Per trans | Per transistor | | | | | |
| I _{CBO} | | $V_{CB} = -30 \text{ V}; I_E = 0 \text{ A}$ | - | - | -15 | nA |
| | current | $V_{CB} = -30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$ | - | - | - 5 | μΑ |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$ | - | - | -100 | nA |
| h _{FE} | DC current gain | $V_{CE} = -5 \text{ V}; I_{C} = -2 \text{ mA}$ | 110 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$ | - | - | -100 | mV |
| | | $I_C = -100 \text{ mA}; I_B = -5 \text{ mA}$ | - | - | -300 | mV |
| V_{BEsat} | base-emitter saturation voltage | $I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$ | - | 700 | - | mV |
| V_{BE} | base-emitter voltage | $I_C = -2 \text{ mA}; V_{CE} = -5 \text{ V}$ | -600 | -650 | -750 | mV |
| | | $I_C = -10 \text{ mA}; V_{CE} = -5 \text{ V}$ | - | - | -820 | mV |
| C _c | collector capacitance | $I_E = I_e = 0 A; V_{CB} = -10 V;$ f = 1 MHz | - | - | 2.5 | pF |
| f _T | transition frequency | $I_C = -10 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz | 100 | - | - | MHz |

^[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

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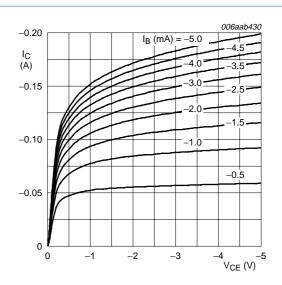
$$V_{CE} = -5 \text{ V}$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

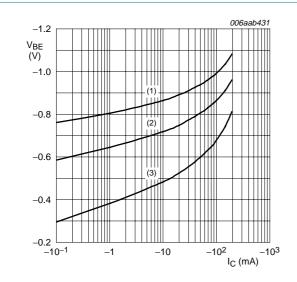
(3) $T_{amb} = -55 \, ^{\circ}C$

Fig 4. Per transistor: DC current gain as a function of collector current; typical values



 $T_{amb} = 25 \, ^{\circ}C$

Fig 5. Per transistor: Collector current as a function of collector-emitter voltage; typical values



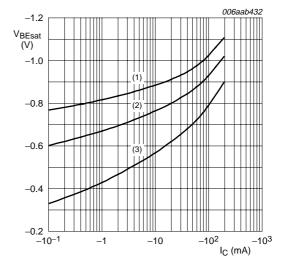


(1)
$$T_{amb} = -55 \,^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 150 \, ^{\circ}C$

Fig 6. Per transistor: Base-emitter voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

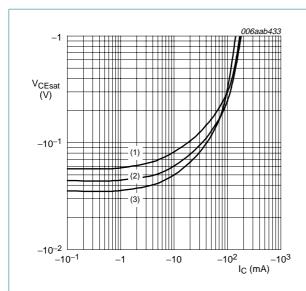
(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = 150 \, ^{\circ}C$

Fig 7. Per transistor: Base-emitter saturation voltage as a function of collector current; typical values

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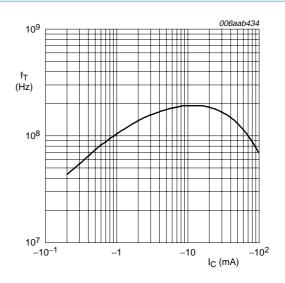
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$$I_{\rm C}/I_{\rm B} = 20$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 8. Per transistor: Collector-emitter saturation voltage as a function of collector current; typical values

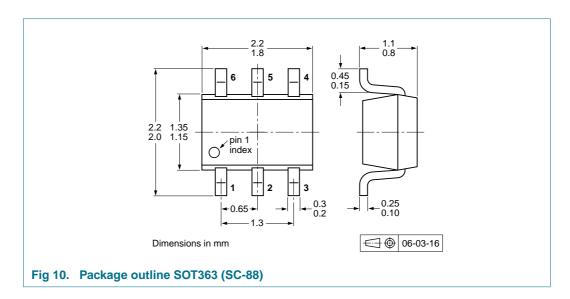


$$V_{CE} = -5 \text{ V}; f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$$

Fig 9. Per transistor: Transition frequency as a function of collector current; typical values

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8. Package outline



9. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | | Packing o | uantity |
|-------------|---------|------------------------------------|-----|-----------|---------|
| | | | | 3000 | 10000 |
| BC856S | SOT363 | 4 mm pitch, 8 mm tape and reel; T1 | [2] | -115 | -135 |
| | | 4 mm pitch, 8 mm tape and reel; T2 | [3] | -125 | -165 |

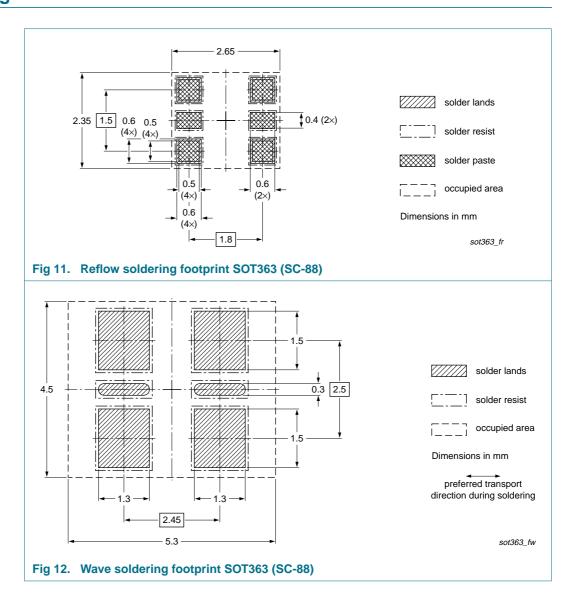
^[1] For further information and the availability of packing methods, see Section 13.

[2] T1: normal taping

[3] T2: reverse taping

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10. Soldering



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11. Revision history

Table 9. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|---|---|------------------------------|---------------|----------------|--|--|
| BC856S_2 | 20090219 | Product data sheet | - | BC856S_1 | | |
| Modifications: | The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. | | | | | |
| Legal texts have been adapted to the new company name where appropries Section 1.2 "Features": adapted | | | | e appropriate. | | |
| | | | | | | |
| | Section 4 "Magnetic Section 4" | Section 4 "Marking": updated | | | | |
| | Section 7 "Characteristics": enhanced | | | | | |
| | Section 9 "Packing information": added | | | | | |
| | Section 10 "Soldering": added | | | | | |
| | Section 12 "L | egal information": updated | | | | |
| BC856S_1 | 19990824 | Product specification | - | - | | |
| | | | | | | |

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12. Legal information

12.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions"
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